

Boréas Technologies

BOS1921CQ/W – Product Presentation

2023-10-04

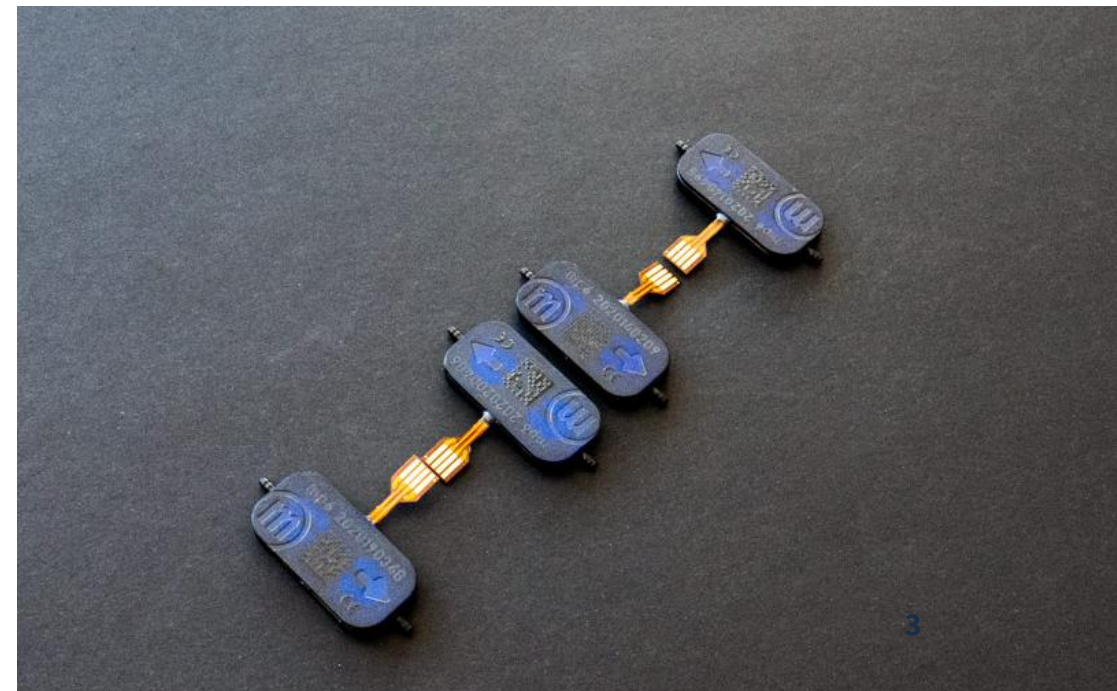
Content

- Applications
- Key Product Features
- Electrical Specifications Summary
- Development Platform

Applications

Many applications exist for the BOS1921.
Below are a few examples:

- Haptic
 - [Trackpad](#)
 - [Smartphone Solid-State Button](#)
 - [Piezo Stylus](#)
 - [Computer Mice](#)
- Non-haptic
 - [Micropump](#)



BOS1921 Key Features

- 190V_{pp} CapDrive™ Bipolar Piezo Driver
 - Drives 100 nF at 190V_{pp} and 300 Hz with only 350 mW
 - Drives capacitive load up to 820 nF
 - Differential Output
- Advanced Piezo Sensing Capabilities
 - 7.6 mV sensing resolution
 - Interrupt Generation
 - Automatic Triggering of Haptic Feedback
- Integrated Digital Front End
 - I3C/I2C with 1.8-5V I/O logic levels
 - 2 kB RAM waveform memory
 - On-chip waveform synthesis
 - State retention in sleep mode
 - 1024 samples FIFO
 - Supports continuous waveform playback
- Multi-Actuator Synchronization
- Unidirectional Power Input (UPI)
- Wide Supply Range, 3 to 5.5 V
- QFN and WLCSP packages available

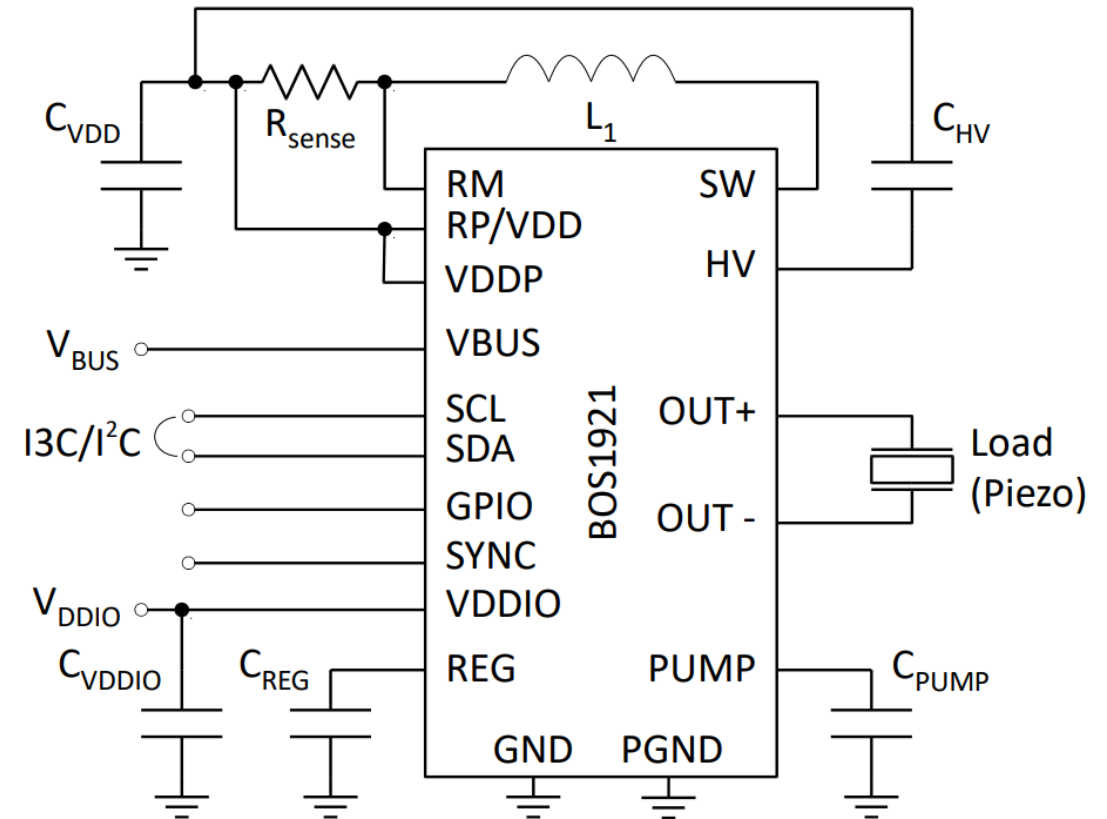
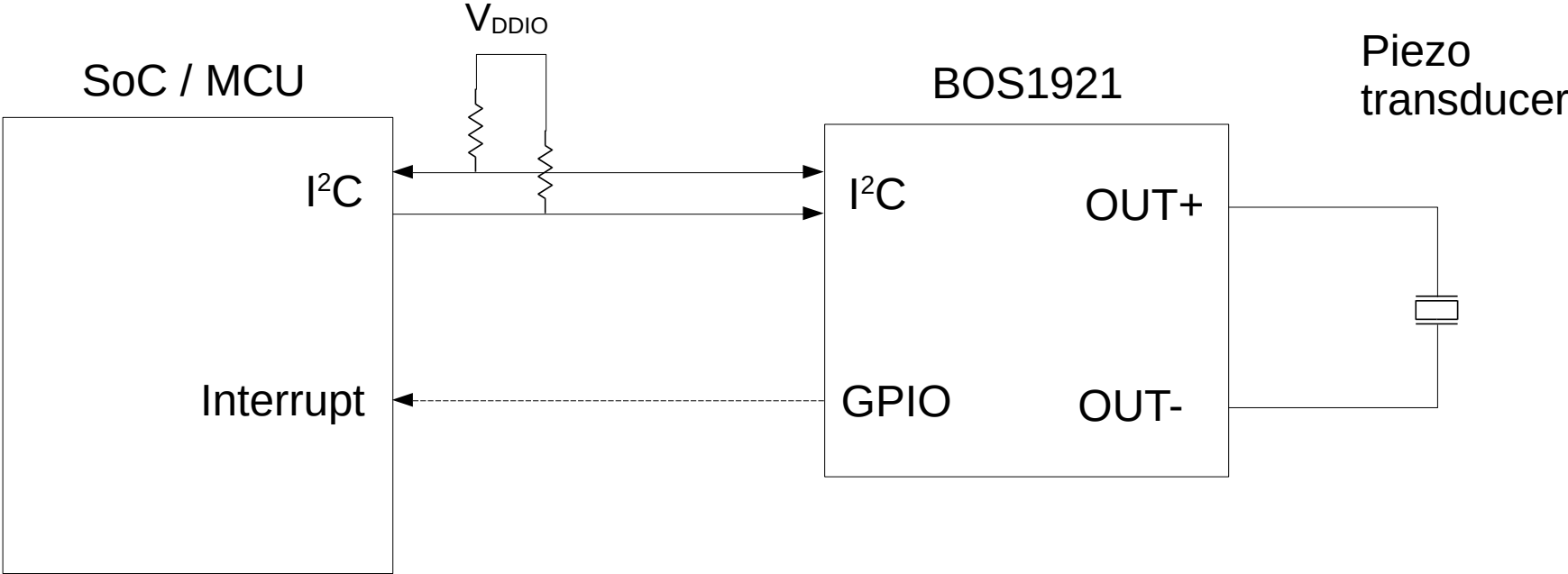


Figure 1: Simplified schematic

Simplified System Block Diagram

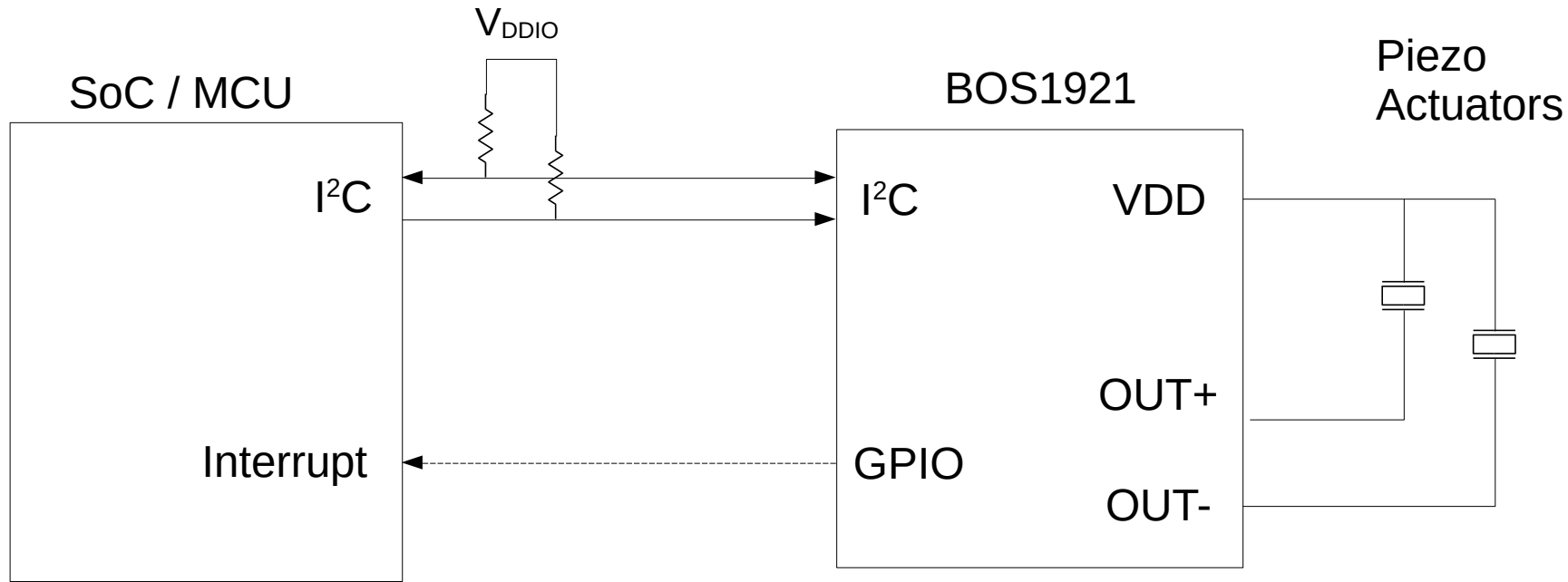
BOS1921 Bipolar Haptic Output & Force Sensing



$V_{DDIO} = 1.8-5 V$

Simplified System Block Diagram

BOS1921 Dual Channel Unipolar* Haptic Driver

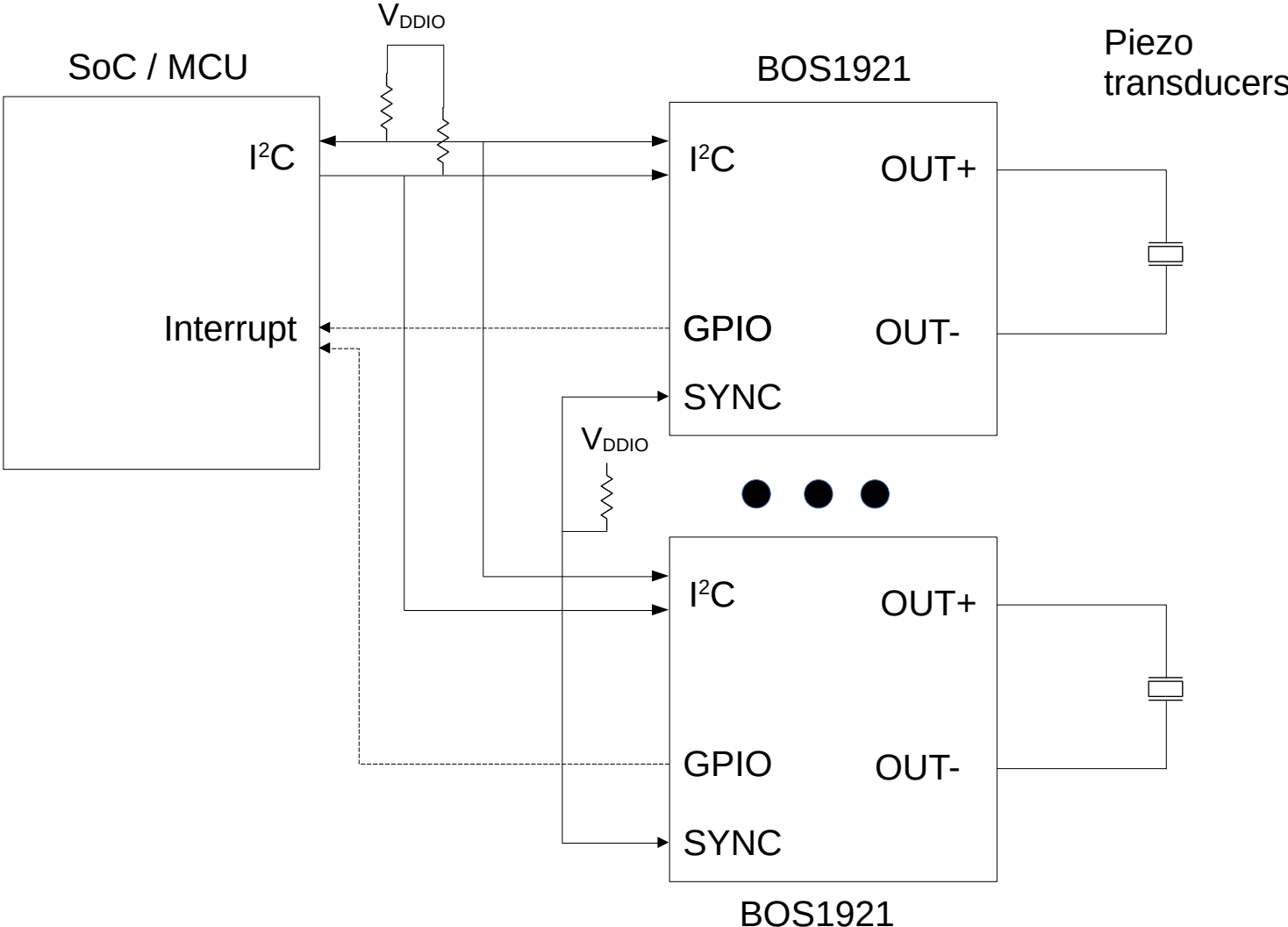


*Each actuator can be driven with a voltage between 0 and 95V. VDD is connected to the negative terminal of each actuator.

$$V_{DDIO} = 1.8-5 V$$

Simplified System Block Diagram

Synchronized multi-actuator BOS1921 system

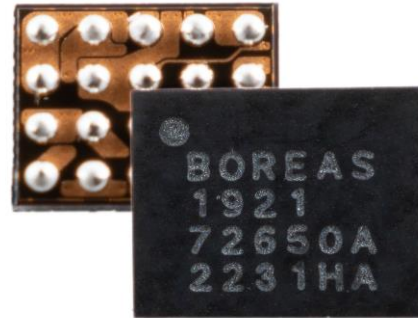


$$V_{DDIO} = 1.8-5 V$$

BOS1921CW Solution Footprint

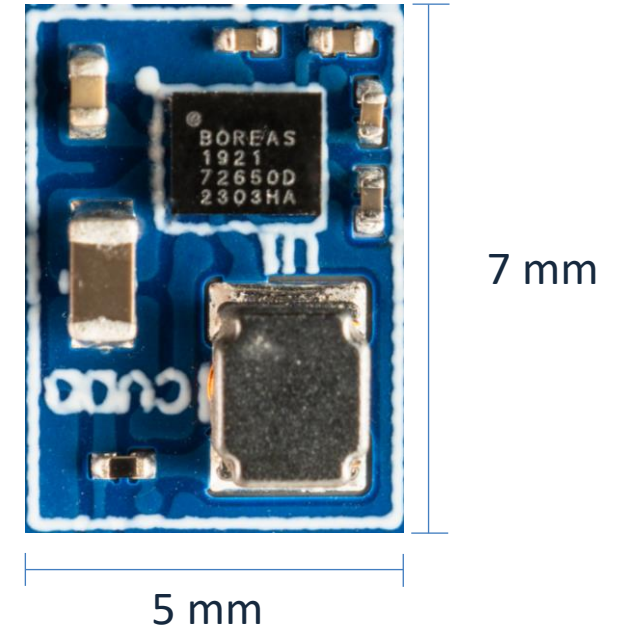
IC size

WLCSP 20 balls
2.1x1.7x0.6 mm
0.4 mm pitch



Typical solution size

5x7 mm
35 mm²



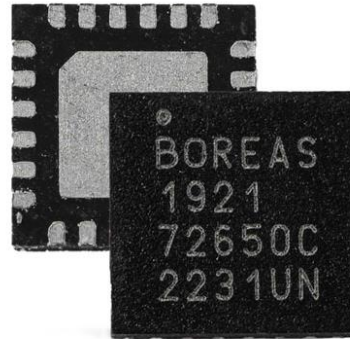
Number of passive components

8

BOS1921CQ Solution Footprint

IC size

QFN 24 pins
4x4x0.55 mm
0.5 mm pitch

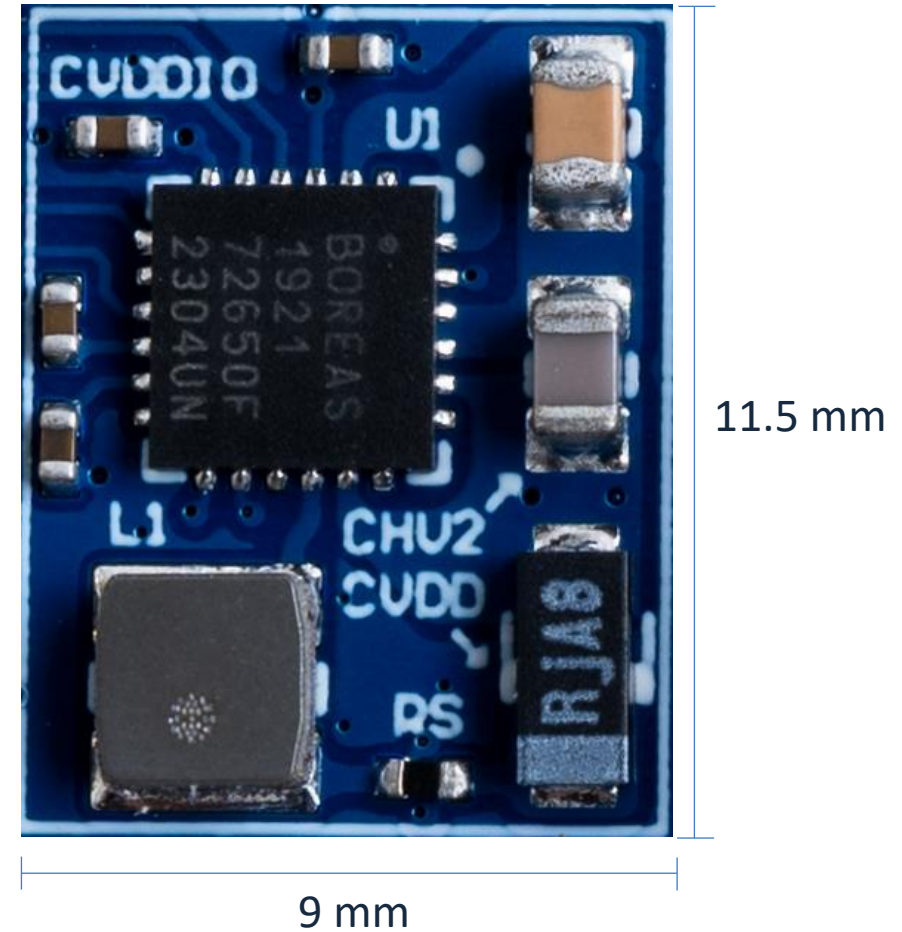


Typical solution size

11.5x9 mm
103.5 mm²

Number of passive components

8



BOS1921 Current Consumption

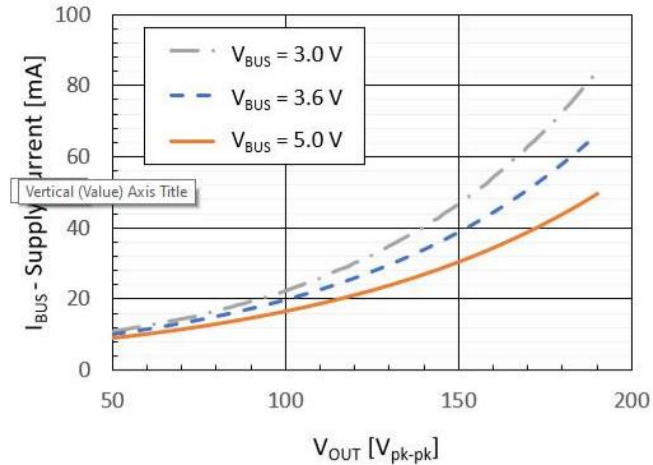
BOS1921 Power consumption is lowest on the market.

Power will vary greatly from one application to the other.

Power scales approximately proportional to:

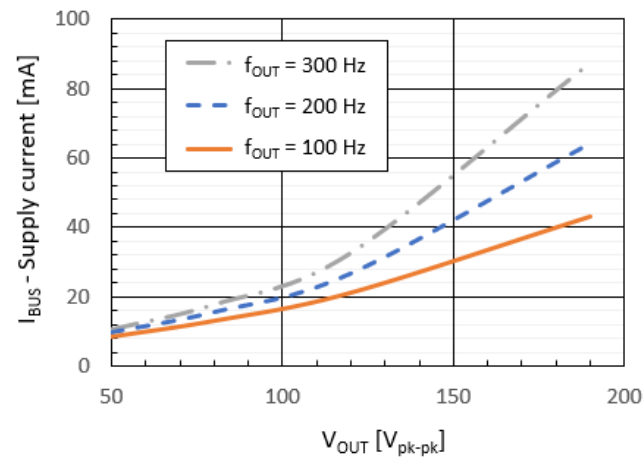
$$\text{Power}_{\text{BOS1921}} \propto f_{\text{sig}} C_{\text{LOAD}} V_{\text{pk}}^2$$

Supply current vs output voltage vs V_{BUS}

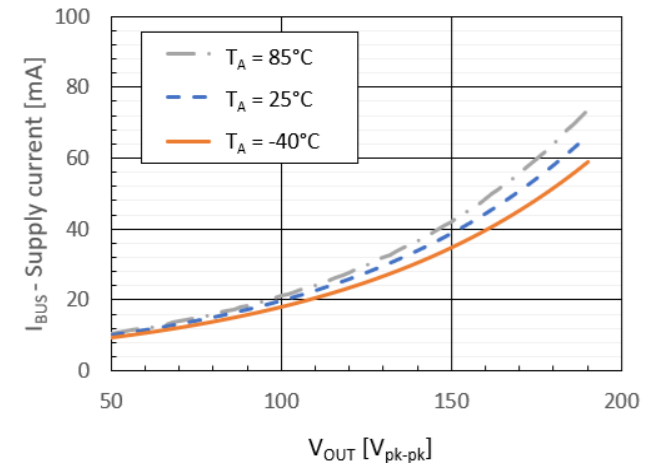


Conditions: $T_A = 25^\circ\text{C}$, $V_{\text{BUS}} = 3.6\text{ V}$,
 $L = 10\ \mu\text{H}$, $C_{\text{Load}} = 100\ \text{nF}$,
 $f_{\text{SIG}} = 200\ \text{Hz}$, sine waveform
 (unless otherwise noted)

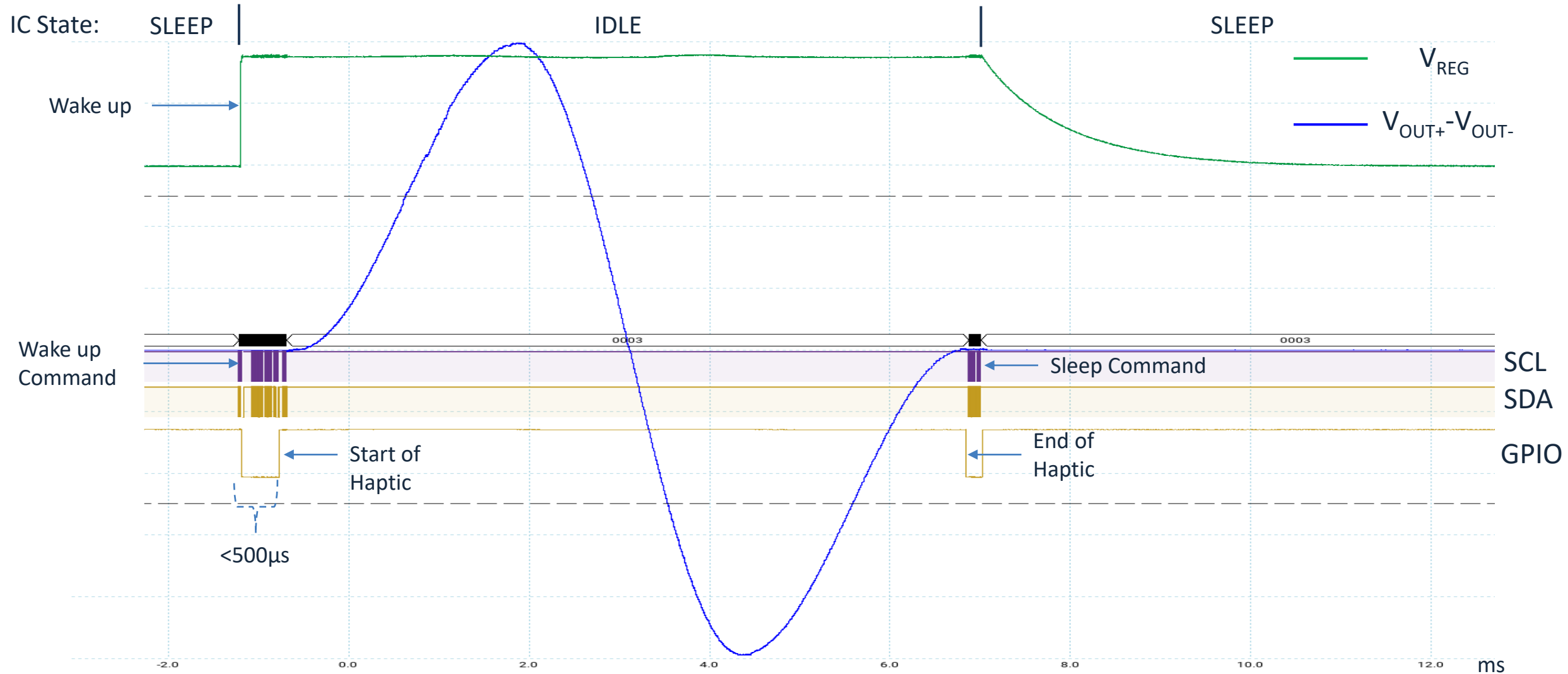
Supply current vs output voltage vs f_{sig}



Supply current vs output voltage vs temperature



Low Latency, Low Power Haptic



Unidirectional Power Input

- Unidirectional Power Input (UPI) is a system that enables the IC to store the recovered energy near the IC
- The benefits of this optional mode are:
 - Reduce the RMS current on the power delivery network (PDN)
 - Prevent forcing current back into the PDN when it would create system level issues

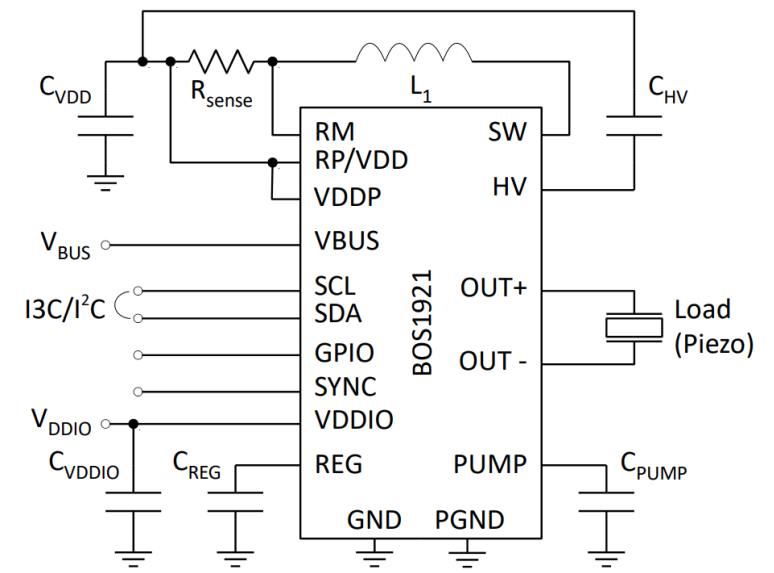
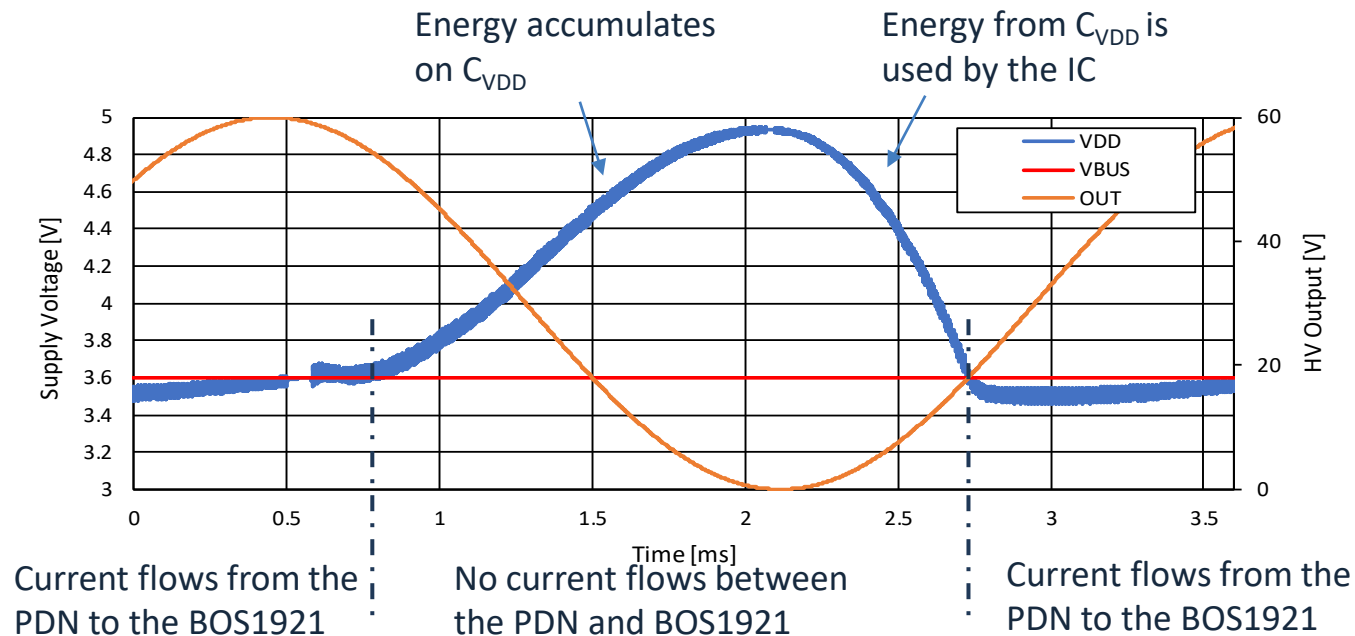


Figure 1: Simplified schematic

Piezo Sensing Interface

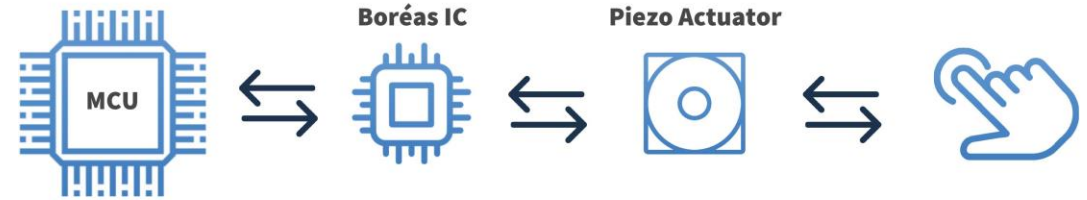
MCU Based Sensing

Resolution: 7.6 mV

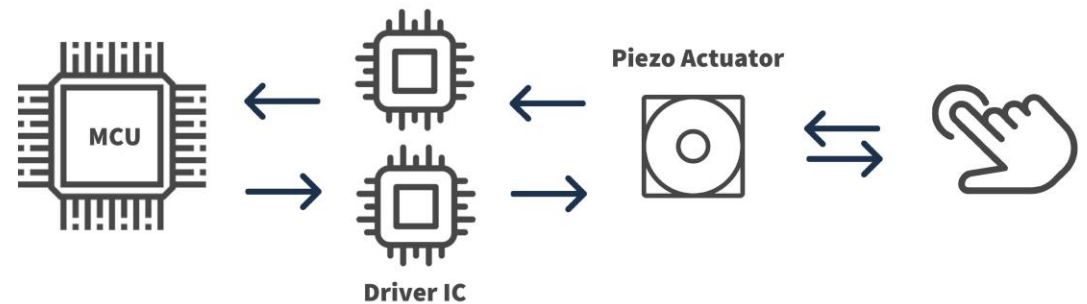
Configurable sensitivity in software

Software available from Boréas

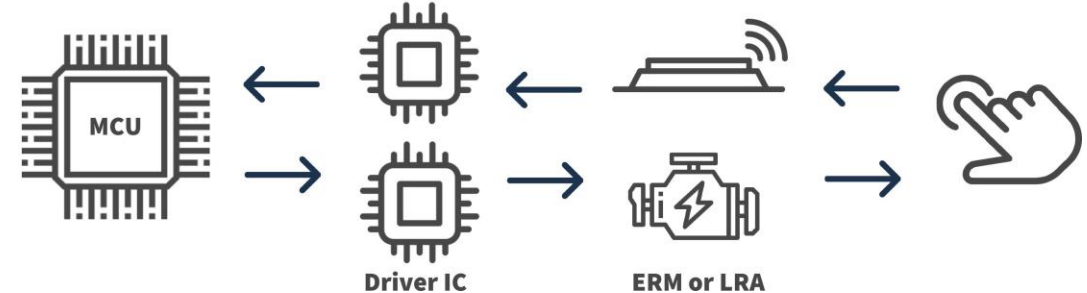
Piezo - Boréas Technologies



Piezo - Competition



Legacy Technologies



Key Electrical Specifications

- Supply
 - V_{BUS} : 3.0V – 5.5V
 - V_{DDIO} : 1.62V – 5.5V
- Waveform output voltage range
 - 0 to $\pm 95\text{V}$ (190 V_{pp})
- Maximum load capacitance
 - See next slide

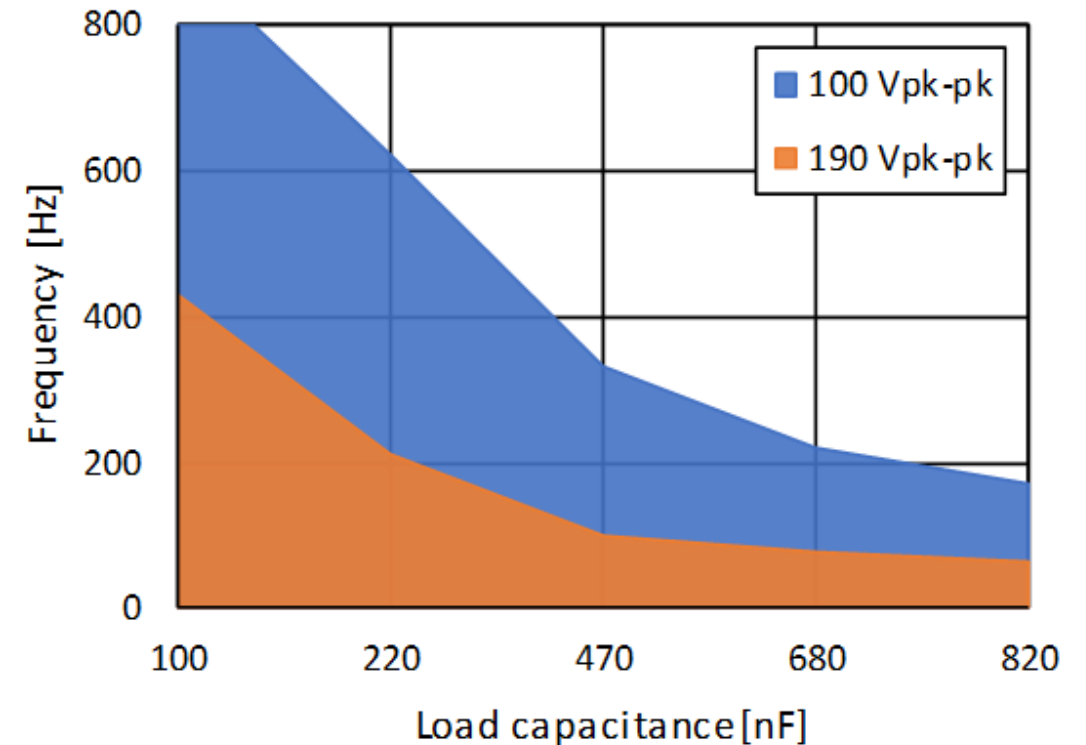
Recommended C_{LOAD}

The BOS1921 has been optimized around loads in the 100s of nF, however, it can also work with smaller or larger loads.

The graph shows the typical load for an output voltage and frequency condition for haptic applications.

It is recommended to use our online tool to analyze easily your application feasibility and recommended BOM.

<https://www.boreas.ca/pages/bos1901-bom-calculator>

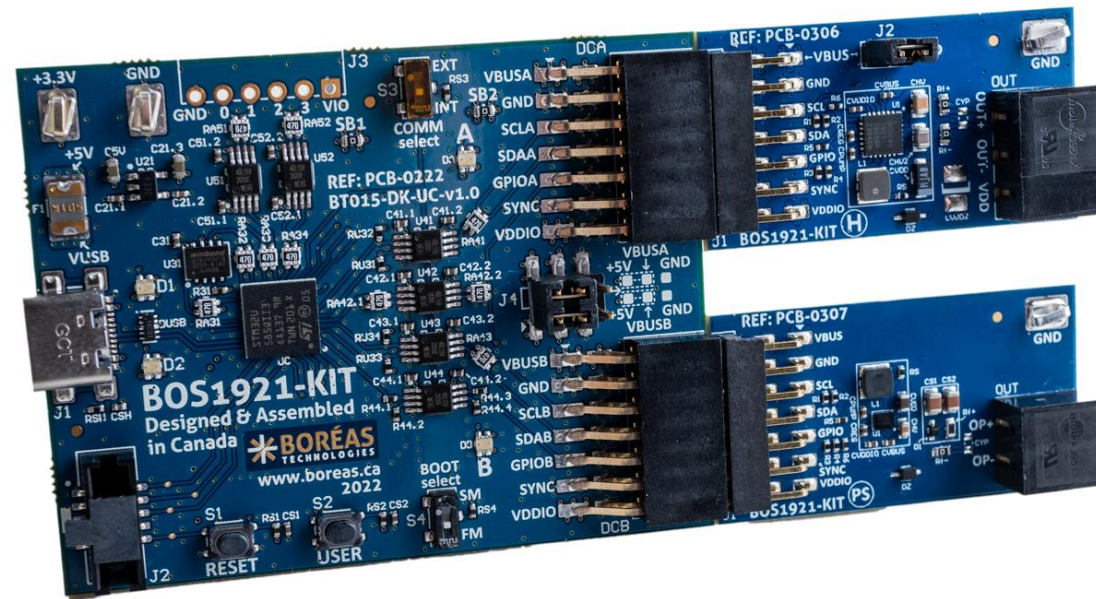


Typical Current Consumption

Symbol	Parameter	Test Conditions*	Typical	Unit
E_{CLICK}	Energy/click	$f_{\text{sig}} = 300 \text{ Hz}$ $V_{\text{OUT}} = 60\text{V}$ $C_{\text{LOAD}} = \text{TDK 1204H018V060}$	0.08	μAh
$I_{\text{Q_VBUS}}$	V_{BUS} supply quiescent current	SLEEP (No state retention)	0.6	μA
		SLEEP (State retention)	2.4	μA
		IDLE	530	μA
$I_{\text{VBUS,AVG}}$	Average V_{BUS} supply current during operation	$f_{\text{sig}} = \text{DC}$ $V_{\text{OUT}} = 95\text{V}$ $C_{\text{LOAD}} = 100 \text{ nF}$	3.7	mA
	Average V_{BUS} supply current during operation	$f_{\text{sig}} = 300 \text{ Hz}$ $V_{\text{OUT}} = 190 \text{ V}_{\text{pk-pk}}$ $C_{\text{LOAD}} = 100 \text{ nF}$	90	mA
	Average V_{BUS} supply current during operation	$f_{\text{sig}} = 200 \text{ Hz}$ $V_{\text{OUT}} = 190 \text{ V}_{\text{pk-pk}}$ $C_{\text{LOAD}} = 10 \text{ nF}$	14.5	mA

* $V_{\text{BUS}} = 3.6\text{V}$, $T_{\text{A}} = 25^{\circ}\text{C}$

BOS1921-KIT



Plug & Play Development Platform

Two Channels

Haptic Configuration for maximum output power

Micropump Configuration for lower power at light load

Small independant BOS1921 driver PCB for easy prototyping and debugging

Easy configuration of Sensing and Haptic behavior

Button Editor

Configurations List

- Button #1
- Button #2

Type: Press/Release Button

Press Threshold	800 mV	Release Threshold	-4000 μ V/ms
Press Debouncing	10 μ s	Release Debouncing	20000 μ s
Press Stabilization	30 ms	Release Stabilization	30 ms
Press Waveform	0-60V-200Hz	Release Waveform	0-60V-200Hz

Buttons

- Button A: Config Button #1
- Button B: Config Button #2

Waveform generation mode
RAM Synthesizer

Output

Slot: Channel A | Actuator: TDK 1204, -10V 60V

Waveform

- 0-60V-200Hz
- Slice #1
- Slice #2

Graph: Voltage (V) vs Time (s). Shows a sine wave with amplitude 50V and frequency 150Hz.

Parameters:

- Mode: Unipolar Positive
- Amplitude: 50 V
- Frequency: 150 Hz
- Cycles: 2
- Half-Cycle Shift 180°:
- Shape Up: 0 ms
- Shape Down: 0 ms

The End

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